

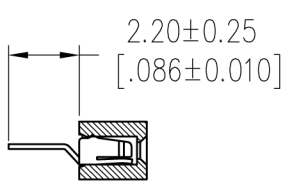
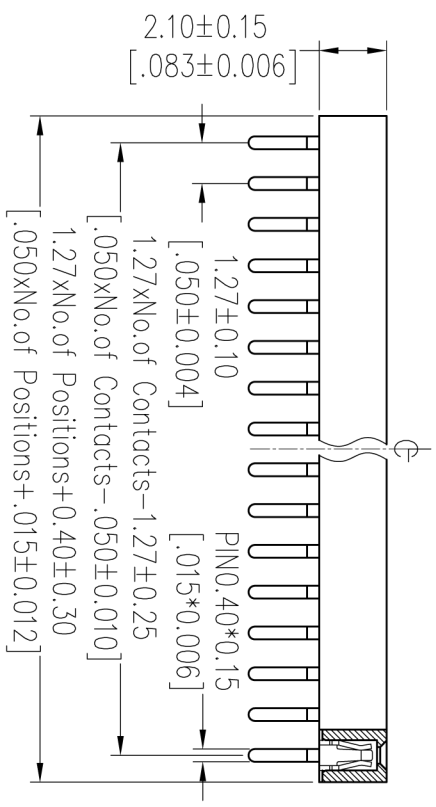
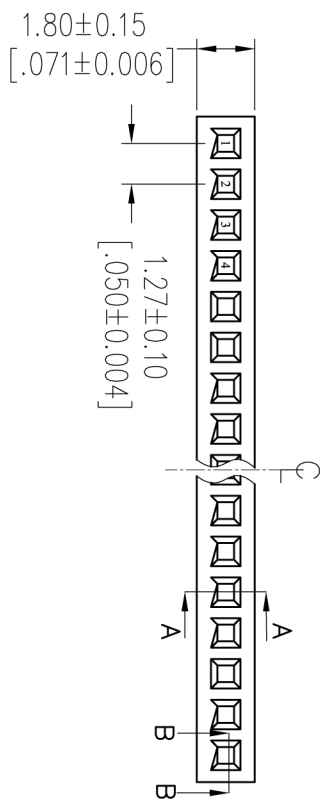
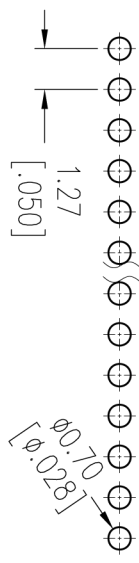
HSHF

NOTES:

Current Rating: 1.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 500V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
 Contact plating: Au over Ni
 Insulator Material: PA9T+30%GF UL94V-0

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



SECTION A-A

SECTION B-B

Ordering Information

2321 - 1 XX S XX CUNT 1

No. of Pins per ROW: 32-50PIN
 Contact Plating:
 G0=Gold Flash
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold

Packing:
 T=Tube

Item	Pitch	Mating
Standard	1.27	1310/1315/1320
Alternate		

		OPERATION		DRAW		DATE		SCALE		PART NO.	
		XX ±0.40		JYhuang		2012/07/06		mm		2321-1XXSXXCUNT1	
		XXX ±0.25		CHECK		DATE		UNIT		TITLE:	
		X.XXX ±0.15						A4		FH1.27mm SINGLE ROW 180° DIP	
		Angle ± 3°		APPROVE		DATE		SHEET 1/1		Customer NO.	
		DIM TOL						PROJ.			
REV		DATE		MODIFICATION DESCRIPTION		CHANGE					
A0		2012/07/06		NEW							
1		2		3		4		5		6	
7		8		9		10					

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